Notice of References Cited Application/Control No. 10/806,680 Applicant(s)/Patent Under Reexamination ARORA ET AL. Examiner Art Unit Page 1 of 1

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
*	Α	US-6,424,141 B1	07-2002	Hollman et al.	324/158.1
*	В	US-6,430,729 B1	08-2002	Dewey et al.	716/4
	С	US-			
	D	US-			
	Ε	US-			
	F	US-			
	G	US-			
	Н	US-			
	ı	US-			
	J	US-			
	К	US-			
	L	US-			
	М	US-			

FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	Z					
	0					
	Ρ					
	α					
	R					
	s					
	Т					

NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)						
	U	Kunikiyo et al.,"Non-Destructive Inverse Modeling of Copper Interconnect Structure for 90 nm Technology Node", Sept. 2003, IEEE International Conference on Simulation Semiconductor Processes and Device, Paper Digest pp. 31 - 34.						
	V	Agilent 4284 A Precision LCR Meter, Data Sheet, 2002, Agilent Technologies, Inc.						
	w							
	х							

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)

Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.